

BTA16, BTB16 T1610, T1635

16 A Snubberless™, logic level and standard Triacs

Features

- Medium current Triac
- Low thermal resistance with clip bonding
- Low thermal resistance insulation ceramic for insulated BTA
- High commutation (4Q) or very high commutation (3Q) capability
- BTA series UL1557 certified (File ref: 81734)
- RoHS (2002/95/EC) compliant
- Insulated tab (BTA series, rated at 2500 V_{RMS})

Applications

- Snubberless versions (BTA/BTB...W and T1635) especially recommended for use on inductive loads, because of their high commutation performances
- On/off or phase angle function in applications such as static relays, light dimmers and appliance motor speed controllers



Description

Available either in through-hole or surface-mount packages, the BTA16, BTB16, T1610 and T1635 Triacs series are suitable for general purpose mains power AC switching.

	se sammary				
Symbol	Parameter	BTA16 ⁽¹⁾	BTB16	T1610	T1635
I _{T(RMS)}	On-state rms current	16	16	16	16
V _{DRM} /V _{RRM}	Repetitive peak off-state voltage	600/800	600/800	600/800	600/800
I _{GT} (Snubberless)	Triggering gate current	35/50	35/50	-	35
I _{GT} (logic level)	Triggering gate current	10	10	10	-
I _{GT} (standard)	Triggering gate current	25/50	25/50	-	-

Table 1. Device summary

1. Insulated

TM: Snubberless is a trademark of STMicroelectronics

1 Characteristics

Table 2.	Absolute	maximum	ratings
	/10001010	maximam	raingo

Symbol	Paramete	Value	Unit		
I	On-state rms current	D ² PAK / TO-220AB	T _c = 100 °C	16	А
I _{T(RMS)}	(full sine wave)	TO-220AB insulated	T _c = 86 °C	10	Υ.
	current		t = 20 ms	160	
ITSM			t = 16.7 ms	168	A
l²t	I ² t value for fusing	t _p = 10 ms		144	A ² s
dl/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , t_r \leq 100 ns	F = 120 Hz	T _j = 125 °C	50	A/µs
V _{DSM} / V _{RSM}	Non repetitive surge peak off-state voltage	t _p = 10 ms	T _j = 25 °C	V _{DRM} /V _{RRM} + 100	V
I _{GM}	Peak gate current	t _p = 20 μs	T _j = 125 °C	4	А
P _{G(AV)}	Average gate power dissipation	1	W		
T _{stg}	Storage temperature range	-40 to + 150			
Тj	Maximum operating junction temperat	-40 to + 125			

Table 3.Electrical characteristics ($T_j = 25$ °C, unless otherwise specified)Snubberless and logic level (3 quadrants)

Symbol	Test conditions	conditions Quadrant T1610 T163		T1635	BTA16 / BTB16			Unit		
Symbol	rest conditions	Quadrant		11010		SW	CW	BW	Unit	
I _{GT} ⁽¹⁾	V _D = 12 V	- -	Max.	10	35	10	35	50	mA	
V _{GT}	$R_L = 33 \Omega$	- -	Max.			1.3			V	
V _{GD}	$V_{D} = V_{DRM}$ R _L = 3.3 kΩ T _j = 125 °C	- -	Min.	Min. 0.2			V			
I _H ⁽²⁾	I _T = 500 mA		Max.	15	35	15	35	50	mA	
1	I _G = 1.2 I _{GT}	I - III	Max.	25	50	25	50	70	mA	
ΙL	IG – I.Z IGT	II	iviax.	30	60	30	60	80	1114	
dV/dt ⁽²⁾	$V_D = 67 \% V_{DRM}$ gate open	T _j = 125 °C	Min.	40	500	40	500	1000	V/µs	
	(dV/dt)c = 0.1 V/µs	T _j = 125 °C		8.5	-	8.5	-	-		
(dl/dt)c (2)	(dV/dt)c = 10 V/µs	T _j = 125 °C	Min.	3.0	-	3.0	-	-	A/ms	
	Without snubber	T _j = 125 °C		-	8.5	-	8.5	14		

1. Minimum IGT is guaranted at 5% of $\rm I_{GT}$ max

2. For both polarities of A2 referenced to A1



Symbol	Test conditions	Quadrant		BTA16	BTB16	Unit
Symbol	Test conditions	Quaurant		С	В	Unit
I _{GT} ⁽¹⁾	$V_{D} = 12 V$ $R_{L} = 33 \Omega$	- - V	Max.	25 50	50 100	mA
V _{GT}		ALL	Max.	1.3		V
V _{GD}	$V_D = V_{DRM} R_L = 3.3 \text{ k}\Omega T_j = 125 \text{ °C}$	ALL	Min.	0.2		V
I _H ⁽²⁾	I _T = 500 mA		Max.	25	50	mA
	1 0 .	I - III - IV	Max.	40	60	mA
ΙL	$I_{G} = 1.2 I_{GT}$	II	IVIAX.	80	120	ШA
dV/dt ⁽²⁾	V _D = 67 %V _{DRM} gate open	T _j = 125 °C	Min.	200	400	V/µs
(dV/dt)c (2)	(dl/dt)c = 7 A/ms	T _j = 125 °C	Min.	5	10	V/µs

Table 4.Electrical characteristics ($T_j = 25$ °C, unless otherwise specified)
standard (4 quadrants)

1. Minimum IGT is guaranted at 5% of $\rm I_{GT}$ max

2. For both polarities of A2 referenced to A1

Table 5.Static characteristics

Symbol	Test conditio	Value	Unit		
V _T (2)	I _{TM} = 22.5 A t _p = 380 μs	T _j = 25 °C	Max.	1.55	V
V _{to} (2)	Threshold voltage	T _j = 125 °C	Max.	0.85	V
R _d (2)	Dynamic resistance	T _j = 125 °C	Max.	25	mΩ
I _{DRM}		T _j = 25 °C	Max.	5	μA
I _{RRM}	$V_{DRM} = V_{RRM}$	T _j = 125 °C	ividX.	2	mA

Table 6.Thermal resistance

Symbol		Value	Unit			
В	lunction to coop (AC)		D ² PAK / TO-220AB	1.2	°C/W	
R _{th(j-c)}	Junction to case (AC)		TO-220AB insulated	2.1	C/ VV	
		$S^{(1)} = 1 \text{ cm}^2$	D ² PAK	45		
R _{th(j-a)}	Junction to ambient		TO-220AB / TO-220AB insulated	60	°C/W	

1. S = Copper surface under tab



2

0

0

2

4

on-state rms current (full cycle) P(W) 20 18 16 14 12 10 8 6 4

I_{T(RMS)}(A)

8

10

12

14

16

Maximum power dissipation versus Figure 2. Figure 1.







6

Figure 4. **Relative variation of thermal** impedance versus pulse duration



Figure 5. **On-state characteristics** (maximum values)

Figure 6. Surge peak on-state current versus number of cycles





Figure 7. Non-repetitive surge peak on-state Figure 8. current for a sinusoidal

e 8. Relative variation of gate trigger current



Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)





Figure 11. D²PAK thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35 µm)





2 Ordering information

Figure 12. Ordering information scheme (BTA16 and BTB16 series)

Insulation A = insulated B = non insulated Current 16 = 16 A Voltage	BT A	16 - 6	500 E	BW F	RG
C = 25 mA Standard SW = 10 mA Logic Level	BW = 50 mA S CW = 35 mA S				
Packing mode RG = Tube					

Figure 13. Ordering information scheme (T16 series)

T 16 35 - 600 G (-TR)
TRIAC series
Current
16 = 16 A
Sensitivity
10 = 10 mA
35 = 35 mA
Voltage
600 = 600 V
800 = 800 V
Package
G = D ² PAK
Packing mode
Blank = Tube
-TR = Tape and reel

Table 7. Product selector

Device ⁽¹⁾	Voltag	e (xxx)	Sensitivity	Туре	Package
Device	600 V	800 V	Sensitivity	туре	Fackage
BTA/BTB16-xxxB	Х	Х	50 mA	Standard	TO-220AB
BTA/BTB16-xxxBW	Х	Х	50 mA	Snubberless	TO-220AB
BTA/BTB16-xxxC	Х		25 mA	Standard	TO-220AB
BTA/BTB16-xxxCW	Х	Х	35 mA	Snubberless	TO-220AB
BTA/BTB16-xxxSW	Х	Х	10 mA	Logic level	TO-220AB
T1610-xxxG	Х	Х	10 mA	Logic level	D ² PAK
T1635-xxxG	Х	Х	35 mA	Snubberless	D ² PAK

1. BTB: non insulated TO-220AB package





3 Package information

- Epoxy meets UL94, V0
- Recommended torque value: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 8. D²PAK dimensions



Figure 14. Footprint (dimensions in mm)

57





		Dimensions							
		Ref.	Mi	illimete	rs		Inches	s	
			Min.	Тур.	Max.	Min.	Тур.	Max.	
		А	15.20		15.90	0.598		0.625	
B	c	a1		3.75			0.147		
ØI <u>b2</u> ,	i•	a2	13.00		14.00	0.511		0.551	
Ţ_ Ţ_		В	10.00		10.40	0.393		0.409	
		b1	0.61		0.88	0.024		0.034	
A .		b2	1.23		1.32	0.048		0.051	
I3		С	4.40		4.60	0.173		0.181	
	c2	c1	0.49		0.70	0.019		0.027	
		c2	2.40		2.72	0.094		0.107	
12 • • • a2		е	2.40		2.70	0.094		0.106	
		F	6.20		6.60	0.244		0.259	
	M ↓ (ØI	3.75		3.85	0.147		0.151	
e		14	15.80	16.40	16.80	0.622	0.646	0.661	
		L	2.65		2.95	0.104		0.116	
		12	1.14		1.70	0.044		0.066	
		13	1.14		1.70	0.044		0.066	
		М		2.60			0.102		

Table 9. TO-220AB (non-insulated and insulated) dimensions



4 Ordering information

Table 10. Ordering information

Order code ⁽¹⁾	Marking ⁽¹⁾	Package	Weight	Base qty	Delivery mode
BTA16-xxxyzRG	BTA16xxxyz	TO-220AB	2.3 g	50	Tube
BTB16-xxxyzRG	BTB16xxxyz	TO-220AB	2.3 g	50	Tube
T1610-xxxG-TR	T1610xxxG			1000	Tape and reel
T1635-xxxG	T1635xxxG	D ² PAK	1.5 g	50	Tube
T1635-xxxG-TR	T1635xxxG			1000	Tape and reel

1. xxx = voltage, y = sensitivity, z = type

5 Revision history

· · · · · · · · · · · · · · · · · · ·			
Date	Revision	Changes	
Oct-2002	6A	Last update.	
13-Feb-2006	7	TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.	
03-Jul-2009	8	Added part number T1610.	
11-Mar-2010	9	Updated value for V_{DSM}/V_{RSM} in <i>Table 2</i> . Updated temperature in <i>Table 2</i> from 15 °C to 86 °C.	

Table 11. Document revision history



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

Doc ID 7471 Rev 9

